

#### Features

- RoHS Compliant (with F or G pin option)
- >40 dB ripple attenuation from 60 Hz to 1 MHz
- Integrated OR'ing diode supports N+1 redundancy
- Significantly improves load transient response
- Efficiency up to 98%
- User selectable performance optimization
- Combined active and passive filtering
- 3 30 Vdc input range
- 20 and 30 Ampere ratings

## **Product Highlights**

Vicor's MicroRAM output ripple attenuation module combines both active and passive filtering to achieve greater than 40 dB of noise attenuation from 60 Hz to 1 Mhz. The MicroRAM operates over a range of 3 to 30 Vdc, is available in either 20 or 30 A models and is compatible with most manufacturers switching converters including all Vicor DC-DC converter models.

The MicroRAM's closed loop architecture greatly improves load transient response and with dual mode control, insures precise point of load voltage regulation, The MicroRAM supports redundant and parallel operation with its integrated OR'ing diode function.

It is available in Vicor's standard Micro package (quarter brick) with a variety of terminations for through hole, socket or surface mount applications.

# Data Sheet *MicroRAM*<sup>™</sup> Output Ripple Attenuation Module





Actual size: 2.28 x 1.45 x 0.5 in 57,9 x 36,8 x 12,7 mm

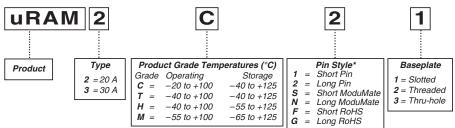
#### **Absolute Maximum Ratings**

| Parameter                 | Rating                 | Unit   | Notes               |
|---------------------------|------------------------|--|---------------------|
| +In to –In                | 30                     | Vdc  | Continuous          |
|                           | 40                     | UIII   | 100ms               |
| Load current              | 40                     | Adc  | Continuous          |
| Ripple Input (Vp-p)       | 100                    | mV   | 60 Hzc 100 kHz      |
|                           | 500                    | mV   | 100 kHz – 2 MHz     |
| Mounting torque           | 4 - 6<br>(0.45 - 0.68) | Vdc 100ms   Adc Continue   mV 60 Hzc   mV 100 kHz   In. lbs 6 each, 4   (Nm) °F (°C) <5 sec; | 6 each, 4-40 screw  |
| Din coldering temperature | 500 (260)              | °F (°C)  | <5 sec; wave solder |
| Pin soldering temperature | 750 (390)              | °F (°C)  | <7 sec; wave solder |

#### **Thermal Resistance**

| Parameter                    | Тур  | Unit    |
|------------------------------|------|---------|
| Baseplate to sink            |      |         |
| flat, greased surface        | 0.16 | °C/Watt |
| with thermal pad (P/N 20265) | 0.14 | °C/Watt |
| Baseplate to ambient         |      |         |
| free convection              | 8.0  | °C/Watt |
| 1000 LFM                     | 1.9  | °C/Watt |

#### Part Numbering



\*Pin styles S & N are compatible with the ModuMate interconnect system for socketing and surface mounting.

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# **ELECTRICAL CHARACTERISTICS**

Electrical characteristics apply over the full operating range of input voltage, output power and baseplate temperature, unless otherwise specified. All temperatures refer to the operating temperature at the center of the baseplate.

#### ■ µRAM MODULE SPECIFICATIONS (-20°C to +100°C baseplate temperature)

| Parameter                               | Min  | Тур       | Max | Unit  | Notes   |
|---|------|-----------|-----|-------|---|
| Operating current range                 |      |           |     |       | No internal current limiting. Converter input must be   |
| µRAM2xxx                                | 0.02 |           | 20  | А     | properly fused such that the µRAM output current        |
| µRAM3xxx                                | 0.02 |           | 30  | А     | does not exceed the maximum operating current           |
|   |      |           |     |       | rating by more than 30% under a steady state condition. |
| Operating input voltage                 | 3.0  |           | 30  | Vdc   | Continuous  |
| Transient output response               |      |           | 50  | mVp-p | Step load change;                                       |
| Load current step <1A/µsec              |      |           | 50  | mvp-p | see Figures 9, 12, & 15, pp. 6-7                        |
| Transient output response               |      |           |     |       | Optional capacitance CTRAN can be used                  |
| Load current step <1A/µsec              |      |           | 50  | mVp-p | to increase transient current capability; See Figures   |
| (CTRAN = 820 µF)                        |      |           |     |       | 1 & 2 on p. 3 and Figures 10, 13, & 16 on pp. 6-7       |
| VHR headroom voltage range <sup>1</sup> | 005  |           | 405 |       | See Figures 5, 6 & 7                                    |
| @ 1A load                               | 325  | 325 425 n |     | mV    | See Table 1 for headroom setting resistor values        |
| Output ripple                           |      |           | 10  | mVp-p | Ripple frequency 60 Hz to 100 kHz; optional capacitor   |
| Input Vp-p = 100 mV                     |      |           | 5   | mVrms | CHR = 100 µF required to increase low frequency         |
|   |      |           |     |       | attenuation as shown in Figures 3a and 3b               |
|   |      |           |     |       | see Figures 8, 11, & 14, pp. 6 – 7                      |
| Output ripple                           |      |           | 10  | mVp-p | Ripple frequency 100 kHz to 2 MHz;                      |
| Input Vp-p = 500 mV                     |      |           | 5   | mVrms | see Figures 8, 11, & 14, pp. 6-7                        |
| SC output voltage <sup>2</sup>          | 1.23 |           |     | Vdc   | See Table 1 RSC value                                   |
| OR'ing threshold                        |      | 10        |     | mV    | Vin – Vout  |
| µRAM bias current                       |      |           | 60  | mA    |   |
| Power dissipation                       |      |           |     |       |   |
| μRAM2xxx VHR = 380 mV@1 A               |      | 7.5       |     | W     | Vin = 28 V; lout = 20 A                                 |
| µRAM3xxx VHR = 380 mV@1 A               |      | 11.5      |     | W     | Vin = 28 V; lout = 30 A                                 |

<sup>1</sup> Headroom is the voltage difference between the +Input and +Output pins.

 $R_{HR} = (\mu RAM + Out/V_{HR}) \times 2.3 k$  (see Table 1 for example values)

<sup>2</sup> SC resistor is required to trim the converter output up to accommodate the headroom of the µRAM module when remote sense is not used. This feature can only be used when the trim reference of the converter is in the 1.21 to 1.25 Volt range. (see Table 1 with calculated Rsc resistor values)

 $Rsc = ((\mu RAM + Out)/1.23 V x 1k) - 2 k$ 

| µRAM Out | VHR @ 1A | RHR Value (ohms) | Rsc Value (ohms) |  |
|----------|----------|------------------|------------------|--|
| 3.0 V    | 375 mV   | 18.4 k           | 0.439 k          |  |
| 5.0 V    | 375 mV   | 30.6 k           | 2.07 k           |  |
| 12.0 V   | 375 mV   | 73.6 k           | 7.76 k           |  |
| 15.0 V   | 375 mV   | 92.0 k           | 10.20 k          |  |
| 24.0 V   | 375 mV   | 147.2 k          | 17.50 k          |  |
| 28.0 V   | 375 mV   | 171.7 k          | 20.76 k          |  |

*Table 1* – RHR and RSC are computed values for a 375 mV case. To compute different headroom voltages, or for standard resistor values and tolerances, use Notes 1 and 2.

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# ELECTRICAL CHARACTERISTICS (CONT.)

#### ■ APPLICATION SCHEMATIC DRAWINGS USING VICOR CONVERTERS AND THE µRAM

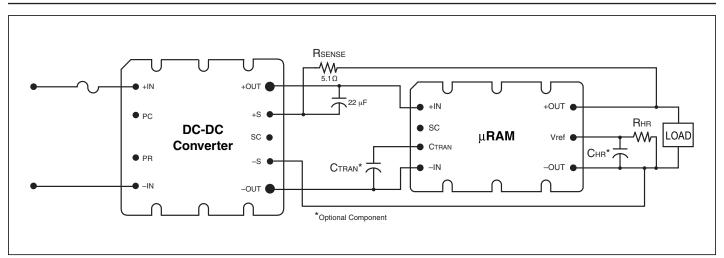


Figure 1 — Typical Configuration using Remote Sensing

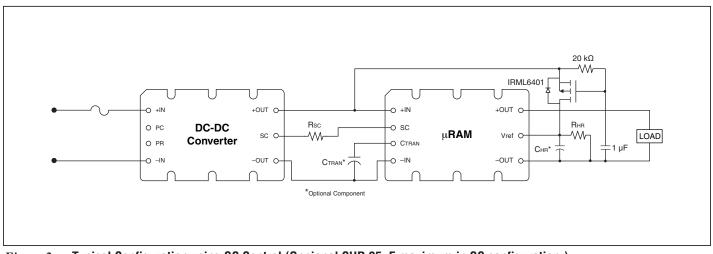


Figure 2 — Typical Configuration using SC Control (Oppional CHR 25µF maximum in SC configuration.)

# FUNCTIONAL DESCRIPTION

The MicroRAM has an internal passive filter that effectively attenuates ripple in the 50 kHz to 1 MHz range. An active filter provides attenuation from low frequency up to the 1 MHz range. The user must set the headroom voltage of the active block with the external RHR resistor to optimize performance. The MicroRAM must be connected as shown in Figures 1 or 2 depending on the load sensing method. The transient load current performance can be increased by the addition of optional CTRAN capacitance to the CTRAN pin. The low frequency ripple attenuation can be increased by addition of optional CHR capacitance to the VREF pin as shown in Figures 3a and 3b, on p. 5. Transient load current is supplied by the internal CTRAN capacitance, plus optional external capacitance, during the time it takes the converter loop to respond to the increase in load. The MicroRAM's active loop responds in roughly one microsecond to output voltage perturbations. There are limitations to the magnitude and the rate of change of the transient current that the MicroRAM can sustain while the converter responds. See Figures 8 – 16, on pp. 6 and 7, for examples of dynamic performance. A larger headroom voltage setting will provide increased transient performance, ripple attenuation and power dissipation while reducing overall efficiency (see Figures 4a, 4b, 4c and 4d on p. 5).

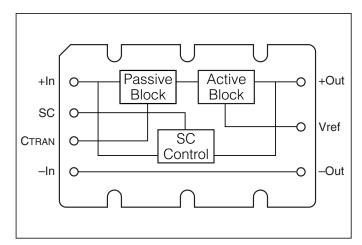
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|-------------|---|---------------------|----------|--------------|
|             |   |                     |          |              |

The active loop senses the output current and reduces the headroom voltage in a linear fashion to approximate constant power dissipation of MicroRAM with increasing loads (see Figures 5, 6 & 7, p. 6). The headroom setting can be reduced to decrease power dissipation where the transient requirement is low and efficient ripple attenuation is the primary performance concern.

The active dynamic headroom range is limited on the low end by the initial headroom setting and the maximum expected load. If the maximum load in the application is 10 Amps, for example, the 1 Amp headroom can be set 75mV lower to conserve power and still have active headroom at the maximum load current of 10 Amps. The high end or maximum headroom range is limited by the internal OR'ing diode function.

The SC or trim-up function can be used when remote sensing is not available on the source converter or is not desirable. It is specifically designed for converters with a 1.23 Volt reference and a 1k ohm input impedance like Vicor Maxi, Mini, Micro converters. In comparison to remote sensing, the SC configuration will have an error in the load voltage versus load current. It will be proportional to the output current and the resistance of the load path from the output of the MicroRAM to the load.

The OR'ing feature prevents current flowing from the output of the MicroRAM back through it's input terminal in a redundant system configuration in the event that a converter output fails. When the converter output supplying the MicroRAM droops below the OR'ed output voltage potential of the redundant system, the input of the MicroRAM is isolated from it's output. Less than 50mA will flow out of the input terminal of the MicroRAM over the full range of input voltage under this condition.



**Block Diagram** 

# **APPLICATION NOTES**

Load capacitance can affect the overall phase margin of the MicroRAM active loop as well as the phase margin of the converter loop. The distributed variables such as inductance of the load path, the capacitor type and value as well as its ESR and ESL also affect transient capability at the load. The following guidelines should be considered when point of load capacitance is used with the MicroRAM in order to maintain a minimum of 30 degrees of phase margin.

- 1) Using ceramic load capacitance with <1 milliohm ESR and <1nH ESL:
  - (a) 20  $\mu$ F to 200  $\mu$ F requires 20 nH of trace/wire load path inductance
  - (b) 200 µF to 1,000 µF requires 60 nH of trace/wire load path inductance

- 2) For the case where load capacitance is connected directly to the output of the MicroRAM, i.e. no trace inductance, and the ESR is >1 milliohm:
  - (a) 20  $\mu$ F to 200  $\mu$ F load capacitance needs an ESL of > 50 nH
  - (b) 200  $\mu$ F to 1,000  $\mu$ F load capacitance needs an ESL of >5 nH
- 3) Adding low ESR capacitance directly at the output terminals of MicroRAM is not recommended and may cause stability problems.
- 4) In practice the distributed board or wire inductance at a load or on a load board will be sufficient to isolate the output of the MicroRAM from any load capacitance and minimize any appreciable effect on phase margin.

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#### µRAM2xxx

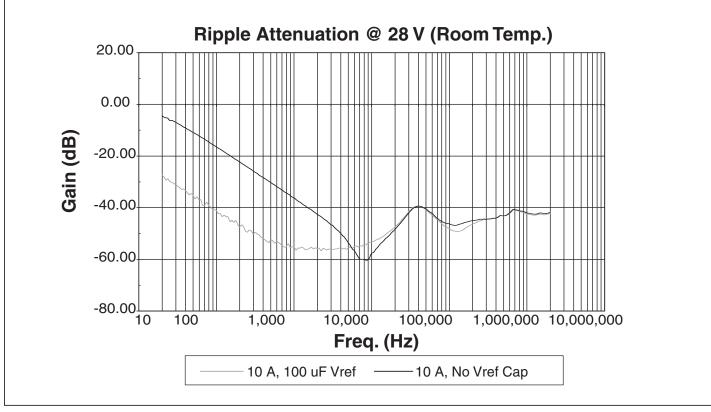
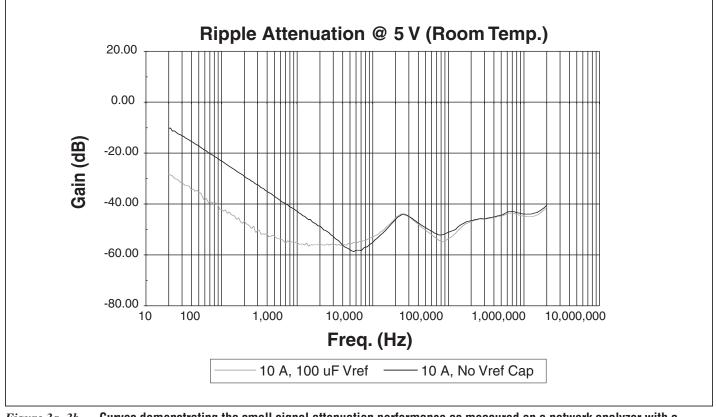
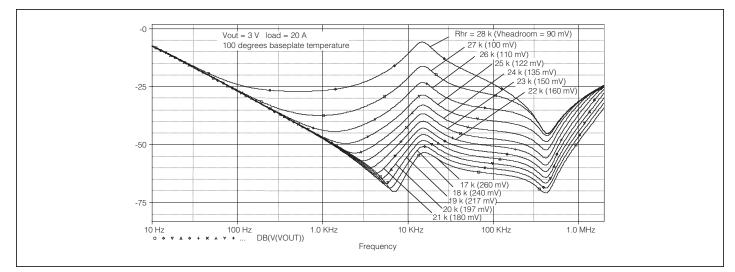


Figure 3a



*Figure 3a, 3b* — Curves demonstrating the small signal attenuation performance as measured on a network analyzer with a typical module at (a) 28 V and 10 A output and (b) 5 V and 10 A. The low frequency attenuation can be enhanced by connecting a 100  $\mu$ F capacitor, CHR, to the VREF pin as shown in Figures 1 and 2.

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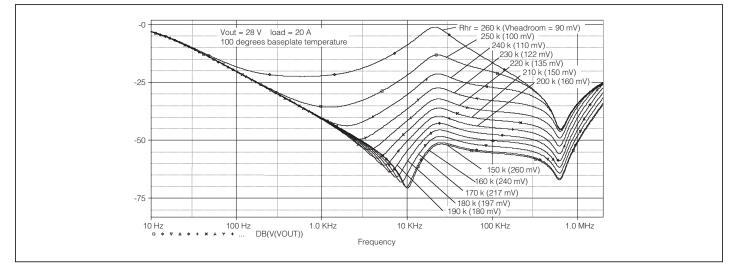
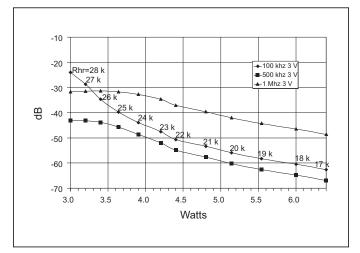


Figure 4a - 4b — Simulated graphs demonstrating the tradeoff of attenuation versus headroom setting at 20 Amps and an equivalent 100°C baseplate temperature at 3 V and 28 V.





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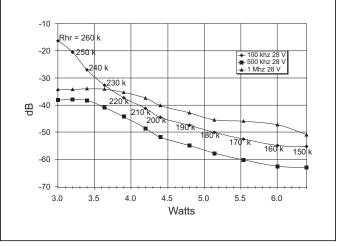


Figure 4c - 4d — MicroRam attenuation vs. power dissipation at 3 V 20 A, and 28 V 20 A.

## **µRAM2xxx** (µRAM3xxx data not included in this rev.)

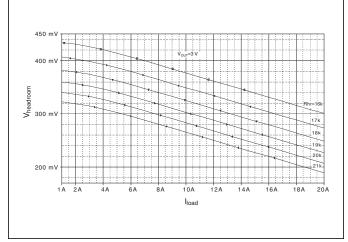


Figure 5 — Headroom vs. load current at 3 V output.

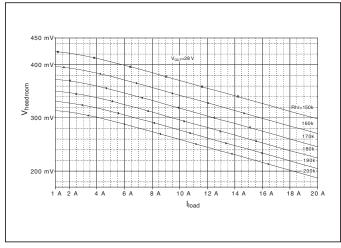


Figure 7 — Headroom vs. load current at 28 V output.

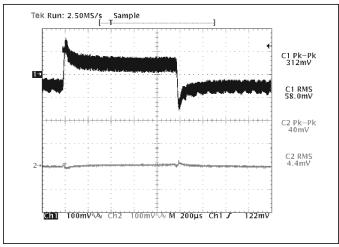


Figure 9 — V375A28C600B and  $\mu$ RAM; Input and output dynamic response no added CTRAN; 20% of 20 A rating load step of 4 A (10 A – 14 A);RHR = 178 k (Configured as in Figs. 1 & 2)

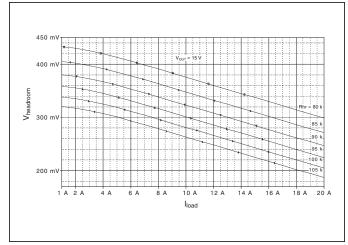


Figure 6 — Headroom vs. load current at 15 V output.

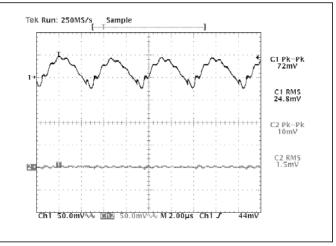


Figure 8 — V375A28C600B and  $\mu$ RAM; Input and output ripple @50% (10 A) load CH1=Vi; CH2=Vo; Vi-Vo=332 mV; RHR=178 k

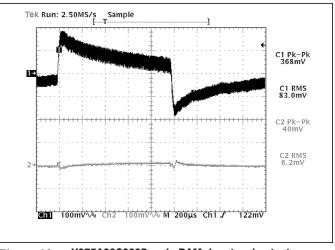


Figure 10 — V375A28C600B and  $\mu$ RAM; Input and output dynamic response CTRAN=820  $\mu$ F Electrolytic; 32.5% of load step of 6.5 A (10 A – 16.5 A);RHR=178 k (Configured as in Figs. 1 & 2)

Notes: The measurements in Figures 8-16 were taken with a µRAM2C21 and standard scope probes with a 20MHz bandwidth scope setting. The criteria for transient current capability was as follows: The transient load current step was incremented from 10A to the peak value indicated, then stepped back to 10A until the resulting output peak to peak was around 40mV.

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#### µRAM2xxx

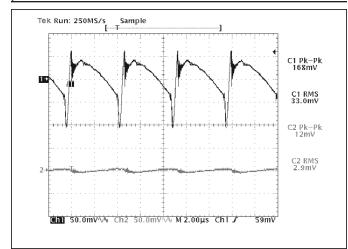


Figure 11 — V375B12C250B and  $\mu$ RAM; Input and output ripple@50% (10 A) load CH1=Vi; CH2=Vo; Vi-Vo=305mV; RHR=80k (Configured as in Figs. 1 & 2)

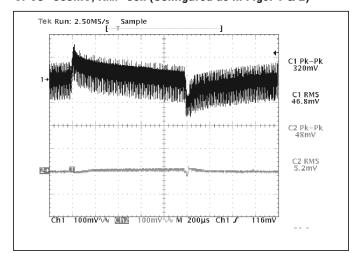


Figure 13 — V300B12C250B and  $\mu$ RAM; Input and output dynamic response CTRAN = 820  $\mu$ F Electrolytic; 30% of load step of 6 A (10 A – 16 A);RHR=80 k (Configured as in Figs. 1 & 2)

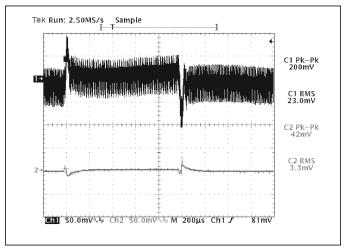


Figure 15 — V48C5C100B and  $\mu$ RAM; Input and output dynamic response no added CTRAN; 22.5% of 20 A rating load step of 4.5 A (10 A – 14.5 A);RHR=31k (Configured as in Figs. 1 & 2)

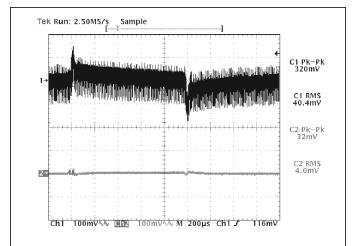


Figure 12 — V300B12C250B and  $\mu$ RAM; Input and output dynamic response no added CTRAN; 17.5% of 20 A rating load step of 3.5 A (10 A – 13.5 A);RHR=80 k (Configured as in Figs. 1 & 2)

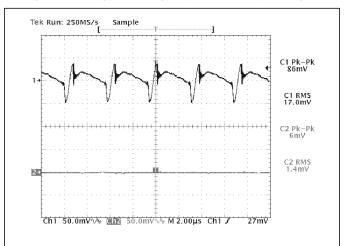


Figure 14 — V48C5C100B and  $\mu$ RAM; Input and output ripple @50% (10 A) load CH1=Vi; CH2=Vo; Vi-Vo=327mV; RHR=31k (Configured as in Figs. 1 & 2)

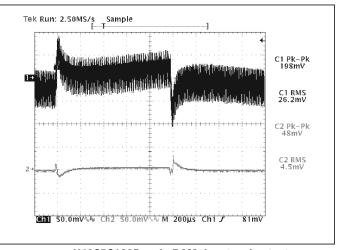


Figure 16 — V48C5C100B and  $\mu$ RAM; Input and output dynamic response CTRAN=820  $\mu$ F Electrolytic; 35% of load step of 7 A (10 A – 17 A);RHR=31 k (Configured as in Figs. 1 & 2)

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# MECHANICAL DRAWINGS

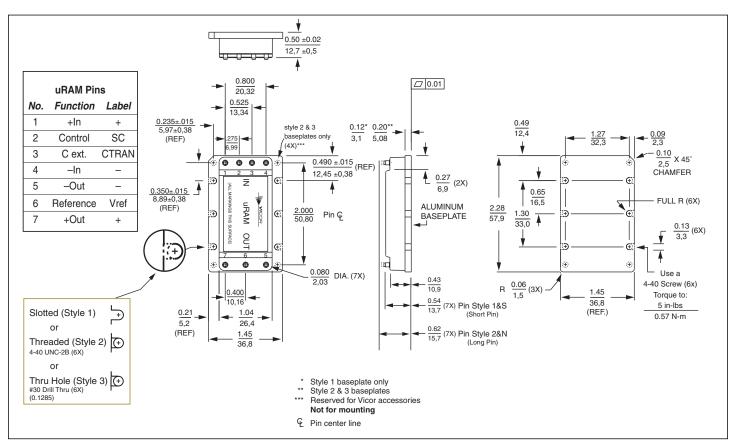
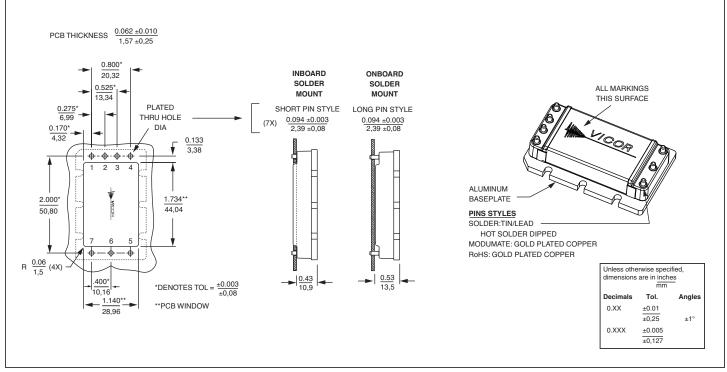


Figure 17 — Module outline



*Figure 18*—PCB mounting specifications

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